



#### Meeting Date: October 4, 2024 Meeting Location: Teleconference

### **VOTING MEMBERS AND 2024 PARTICIPANTS**

Altair AMD (Xilinx) Analog Devices

Ansys Ansys Japan Applied Simulation Technology Aurora System Broadcom Cadence Design Systems

Celestica Cisco Systems Dassault Systemes GE Healthcare Technologies Google Huawei Technologies Infineon Technologies AG Instituto de Telecomunicações Intel Corporation

**Keysight Technologies** 

Marvell MathWorks Micron Technology MST EMC Lab

SI-Clarity Siemens EDA

**STMicroelectronics** 

Synopsys

Teraspeed Labs Waymo ZTE Corporation Zuken Zuken USA (JuneSang Lee) (Bassam Mansour) Jermaine Lim-Abroguena, Toni Rose Racelis, Christine Bernal, Prachi Shukla, Aprille Hernandez-Loyola, Francis Ian Calubag, Marvin Sinues, Vincent Paul Sabillo, Esther Grace Falate, Keshav Mehrotra Curtis Clark\*, Marco Occhiali Satoshi Endo (Fred Balistreri) (Dian Yang), Raj Raghuram (Yunong Gan) Kyle Lake\*, Ambrish Varma, Jared James, John Phillips, Kristoffer Skytte, Baolong Li (Sophia Feng) (Stephen Scearce), Hong-Man Wu Stefan Paret, David Duque (Balaji Sankarshanan) (Hanfeng Wang) (Hang (Paul) Yan) (Christian Sporrer) (Abdelgader Abdalla) Michael Mirmak, Hsinho Wu\*, Kinger Cai, Chi-te Chen, Sleiman Bou-sleiman Pegah Alavi, Ming Yan, David Banas, Fangyi Rao, HeeSoo Lee, Heidi Barnes Steven Parker, Shaowu Huang, Wei Zhang Graham Kus\*, Walter Katz\* Justin Butterfield Chulsoon Hwang\*, Zhiping Yang\*, Jiahuan Huang, Yifan Ding, Zheben Peng, Xiangrui Su, DongHyan "Bill" Kim Doug Burns\* Weston Beal\*, Arpad Muranyi\*, Randy Wolff\*, Matt Leslie, Scott Wedge, Todd Westerhoff, Zhichao Deng Anil-Kumar Dwivedi, Bhupendra Singh, Harsh Saini, Hemant Kumar Gangwar, Manda Padma Sindhuja, Manish Bansal, Nitin Kumar, Olivier Bayet, Pawan Verma, Pranav Singh, Rahul Kumar, Raushan Kumar, Shivam Soni, Gaurav Goel, Manisha Bisht, Charul Sharma, Manish Bansal. Mihir Pratap Ted Mido\*, (Andy Tai), Luis Simoes, Pedro Monteiro, Luis Neves, António Eustáquio, Diogo Coelho, Nuno Lima, Alexandre Brito (Tom Dagastino), [Bob Ross] (Feng Wang), [Ji Zhang] (Zhongmin Wei), (Shunlin Zhu) (Ralf Brüning), Markus Bücker Lance Wang\*

#### **OTHER PARTICIPANTS IN 2024**

Alphawave Semi Anacom Apple Inc. Applied Logix Ciena **Hirel Logic HRL** Laboratories Hitachi Ltd. IBM Kandou **KEI Systems KT Smart Future-Creations** Meta Northrop Grumman Corp. Qualcomm Rivos Samsung Electronics SAE ITC Signal Edge Solutions Si-Guys Socionext America **Teraspeed Labs** Toyobo Co. University of Illinois Urbana-Champaign UNIST Zhejiang University

Adrien Auge, Todd Bermensolo Filipe Saraiva Ying Cao Dan Chirpich Hugues Tournier, Kaisheng Hu Jason Riddley John Carlson Yutaka Uematsu Matteo Cocchini Sherman Chen Shinichi Maeda Keita Mivasato Ashkan Hashemi, Himanshu Modi Will McCaffrey Scott Powers Yanshen Wang Jun-Bae Kim, Changsoo Yoon Tammy Patton\*, Rich Demary Beniamin Dannan Donald Telian Futoshi Terasawa [Bob Ross] Saki Kawano Jose Schutt-Aine Jingook Kim Ling Zhang

In the list above, attendees present at the meeting are indicated by "." Those submitting an email ballot for their member organization for a scheduled vote are indicated by "^." Principal members or other active members who have not attended are in parentheses "()." Participants who no longer are in the organization are in square brackets "[]."

## **UPCOMING MEETINGS**

The connection information for future IBIS teleconferences is as follows:

Microsoft Teams meeting Join on your computer or mobile app Click here to join the meeting

Join with a video conferencing device 106010980@teams.bjn.vc Video Conference ID: 114 666 897 5 Alternate VTC dialing instructions

## Or call in (audio only)

<u>+1 267-768-8015,554664847#</u> United States, Philadelphia Phone Conference ID: 554 664 847# <u>Find a local number | Reset PIN</u> <u>Learn More | Meeting options</u> All teleconference meetings are 8:00 a.m. to 9:55 a.m. US Pacific Time. Meeting agendas are typically distributed seven days before each Open Forum. Minutes are typically distributed within seven days of the corresponding meeting.

NOTE: "AR" = Action Required.

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### INTRODUCTIONS AND MEETING QUORUM

Roll Call: Graham Kus announced a total of 9 organization members attending with quorum of 7 met.

# CALL FOR PATENTS

Lance Wang called for declaration of any patents or pending patents related to the IBIS, IBIS-ISS, ICM, or Touchstone 2.0 specifications.

### **REVIEW OF MINUTES AND ARs**

- August 9, 2024 IBIS Summit at IEEE EMC+SIPI 2024 pending update.
- August 23, 2024 IBIS Open Forum Teleconference pending update.
- September 13, 2024 IBIS Open Forum Teleconference pending update.
- Lance to address broken recording links for August 9, 2024 IBIS Summit.

## ANNOUNCEMENTS, CALL FOR ADDITIONAL AGENDA ITEMS

Lance Wang called for any new announcements. No new agenda items.

#### MEMBERSHIP STATUS AND TREASURER'S REPORT

No updates from SAE ITC on open items since the September 13 update. 1 member renewal payment is still in progress (AMD) and a 2<sup>nd</sup> for a Parser license. A TSCHK2 parser source code license purchase is completed, but the invoice payment has not been recorded yet (\$1,000). We have 28 members with a quorum of 7.

No change since September 13:

**\$13,255** Balance for 2024

**\$22,705** Adjusted Net Income for 2024 (adding the 2024 IBIS membership renewals received in 2023)

#### WEBSITE ADMINISTRATION

Lance Wang reported for Steve Parker that website status: IBIS Summit registration for Shanghai is live. The upcoming IBIS Events page has been updated with Sponsorship information for both the Japan and China IBIS Summits. Also, Steve has paid annual hosting fee to Bluehost and is seeking reimbursement. Most recent minutes received from Secretary have been posted. For Web 2024, there is a plan to move to app based upload of meeting minutes by ourselves and not require Steve to conduct the task.

No questions were asked.

# MAILING LIST

Curtis Clark reported nothing new to report.

## LIBRARY UPDATE

Zhiping Yang reported no updates.

### INTERNATIONAL/EXTERNAL ACTIVITIES

Lance Wang reported that the IEEE has a new conference regarding Interconnect with a new conference starting this year regarding the topic. This will be held in China the end of October or beginning of November. Lance is considering next year, whether to hold an IBIS summit with the IEEE event at that time. Zhiping stated the name is IEEE Workshop for Advanced Interconnect. This year is November 6-8 in China arranged by Professor Lee. The plan is to hold this annually as a conference. Lance stated we would like to determine whether it could be a co-sponsored event.

- Link: http://www.wai-emc.com/

On another topic, Zhiping stated he attended a conference related to JEDEC on Automotive and Memory related topics:

- Link: <u>https://www.jedec.org/Automotive-Electronics-Forum-attendees-only-2024-San-Jose</u> IEC 63055/IEEE 2401, JEITA "LPB:"

- Lance Wang reported on behalf of Michael Mirmak there are no updates.

Press Updates:

- No updates reported.

University Relations:

- No updates reported.

## SUMMIT PLANNING AND REVIEW

#### Asian IBIS Summits:

Lance Wang reported that the dates are now set as follows:

- Link: <u>www.ibis.org/events</u>

#### Japan IBIS Summit (October 22, 2024)

- Location: JEITA Office Building, Tokyo, Japan & Online.

Lance stated this conference would be translated.

- <u>Sponsors</u>:
- ANSYS, Inc.
- Apollo Giken Co.,Ltd.
- IBIS Open Forum
- JEITA EC Center
- Keysight Technologies Japan K.K.
- Seiko Epson Corporation
- Toshiba Corporation
- Zuken Inc.

China IBIS Summit (October 25, 2024)

- Location: Parkyard Hotel, Shanghai, PR China

Lance stated there are 20+ registered at present. There are 4 Sponsors that are committed:

- <u>Sponsors</u>:
- Ansys
- Empyrean Technology
- Aurora System
- Cadence Design Systems

Notes: Lance reported there may be issues with time zones, as this would be midnight East-Coast US time. There may be presentations that are presented by proxy; with questions answered after the event.

# QUALITY TASK GROUP

Randy Wolff reported there is main work on the Parser Specification for each of the new BIRDs that will be part of IBIS 8.0. Main thing is discussing BIRD229.1 – how the Parser can impute data to the .dll/.so files in order to check for the AMI value root\_name, in order to make sure the Parser checks the root\_name AMI value matches the AMI file.

Note: The Quality Task Group checklist and other documentation can be found at:

https://ibis.org/quality\_wip/

# ADVANCED TECHNOLOGY MODELING TASK GROUP

Arpad Muranyi reported we are meeting on Tuesdays at Noon Pacific time. In the last few meetings discussed 2 topics. BIRD220.1 proposals. We asked Yifan Ding to run a few more experiments on PSIJ parameters would or would not work. A new draft could be submitted to open forum soon. Another from Michael Mirmak, parser related, regarding to what the meaning of Ramp numbers are, in presence of other parameters. As we were looking into all those, we discovered quite a few areas in the specification that may need clarification. We are discussing those details.

Note: Task group material can be found at:

https://ibis.org/macromodel\_wip/

## INTERCONNECT TASK GROUP

Michael Mirmak reported via email: no update to interconnect.

There was discussion about Touchstone S-Parameter vs. RLC models of ports vs. return path.

Note: Task group material can be found at:

https://ibis.org/interconnect\_wip/

## EDITORIAL TASK GROUP

Michael Mirmak reported via email: the team is working on a third draft of IBIS 8.0. All approved BIRDs since IBIS 7.2 have been integrated, as have all known issues in IBIS 7.2. Significant editing is still needed to ensure consistency between the largest BIRDs and the rest of the document. Meetings continue every Friday at 8am when the Open forum is not scheduled.

Randy Wolff stated there is much work to do and help is appreciated.

Note: Task group material can be found at:

https://ibis.org/editorial\_wip/

## **NEW ADMINISTRATIVE ISSUES**

IBIS membership structure change discussions

- IBIS parser source-code purchase price change
- Lance Wang reported that there was consideration whether to have different pricing for large company/high seat count vs. small company/low seat count.
- Randy Wolff stated that we are waiting to get more information on budgeting and actual costs are from SAE-ITC, which would help define these metrics.
- There was additional discussion on Budget topic which was tabled for an Officer's meeting at a later date.

# **ROLL CALL**

Mid-meeting roll call: Graham Kus reported 9 member attendees meeting quorum requirements.

## **TECHNICAL DISCUSSION**

No new items.

**NEW AND REVISED IRDs** 

None.

# **IRDS ELIGIBLE FOR VOTE**

None.

## **IRDS SCHEDULED FOR VOTE**

None.

# TABLED IRDS

BIRD220: Pre-driver PSIJ Sensitivity keyword.

Arpad Muranyi stated this was still being discussed.

- Link: https://ibis.org/birds/bird220.docx

# **IBISCHK AND TSCHK PARSER AND BUG STATUS**

Randy Wolff reported working on specification for IBISCHK 8. There may be a bug submitted soon depending on discussions in ATM regarding Ramp keyword. Nothing submitted yet.

## **NEW TECHNICAL ISSUES**

None.

# NEXT MEETING AGENDA AND SCHEDULING

Lance Wang stated the next IBIS Open Forum meeting would be held as a teleconference meeting on November 1, 2024. The following meeting would be held November 22, 2024. Lance asked if there were any concerns. None were raised.

Arpad Muranyi motioned to adjourn. Doug Burns seconded the motion. The meeting adjourned.

NOTES IBIS CHAIR: Lance Wang (978) 633-3388 lance.wang@ibis.org Solutions Architect, Zuken USA 238 Littleton Road, Suite 100 Westford, MA 01886 VICE CHAIR: Douglas Burns vice-chair@ibis.org CEO and Signal and Power Integrity Consultant, SI-Clarity, LLC. SECRETARY: Graham Kus graham.kus@ibis.org Senior Engineer, The MathWorks, Inc. 3 Apple Hill Drive Natick, MA 01760 **TREASURER: Randy Wolff** randy.wolff@siemens.com Product Architect, Siemens EDA LIBRARIAN: Zhiping Yang YangZhip@mst.edu WEBMASTER: Steven Parker (845) 372-3294 sparker@marvell.com Senior Staff Engineer, DSP, Marvell 2070 Route 52 Hopewell Junction, NY 12533-3507 **POSTMASTER:** Curtis Clark curtis.clark@ansys.com Ansys, Inc. 400 Fifth Avenue Suite 500 Waltham, MA 02451 This meeting was conducted in accordance with SAE ITC guidelines. All inquiries may be sent to info@ibis.org. Examples of inquiries are:

- To obtain general information about IBIS.
- To ask specific questions for individual response.
- To subscribe to or unsubscribe from the official <u>ibis@freelists.org</u> and/or <u>ibis-users@freelists.org</u> email lists (formerly <u>ibis@eda.org</u> and <u>ibis-users@eda.org</u>):

- o <u>https://www.freelists.org/list/ibis</u>
- o https://www.freelists.org/list/ibis-users
- To subscribe to or unsubscribe from one of the Task Group email lists: <u>ibis-macro@freelists.org</u>, <u>ibis-interconn@freelists.org</u>, <u>ibis-editorial@freelists.org</u>, or <u>ibis-quality@freelists.org</u>:
  - o https://www.freelists.org/list/ibis-macro
  - o <u>https://www.freelists.org/list/ibis-interconn</u>
  - o https://www.freelists.org/list/ibis-editorial
  - o https://www.freelists.org/list/ibis-quality
- To inquire about joining the IBIS Open Forum as a voting Member.
- To purchase a license for the IBIS parser source code.
- To report bugs or request enhancements to the free software tools: ibischk7, tschk2, icmchk1, s2IBIS, s2IBIS2 and s2iplt.

The BUG Report Form for ibischk resides along with reported BUGs at:

https://ibis.org/bugs/ibischk/ https://ibis.org/ bugs/ibischk/bugform.txt

The BUG Report Form for tschk2 resides along with reported BUGs at:

https://ibis.org/bugs/tschk/ https://ibis.org/bugs/tschk/bugform.txt

The BUG Report Form for icmchk resides along with reported BUGs at:

https://ibis.org/bugs/icmchk/ https://ibis.org/bugs/icmchk/icm\_bugform.txt

To report s2IBIS, s2IBIS2 and s2iplt bugs, use the Bug Report Forms which reside at:

https://ibis.org/bugs/s2IBIS/bugs2i.txt https://ibis.org/bugs/s2IBIS2/bugs2i2.txt https://ibis.org/bugs/s2iplt/bugsplt.txt

Information on IBIS technical contents, IBIS participants and actual IBIS models are available on the IBIS Home page:

https://ibis.org/

Check the IBIS file directory on IBIS.org for more information on previous discussions and results:

https://ibis.org/directory.html

Other trademarks, brands and names are the property of their respective owners.

# SAE STANDARDS BALLOT VOTING STATUS (attendee X; absent -)

		Standard s Ballot Voting	Aug 9,	Aug 23,	Sept 13,	Oct 4,
Organization	Interest Category	Status	2024	2024	2024	2024
Altair	User	Inactive	-	-	-	-
AMD (Xilinx)	Producer	Inactive	-	-	-	-
Analog Devices	Producer	Inactive	Х	-	-	-
Ansys	User	Active	Х	Х	Х	Х
Applied Simulation Technology	User	Inactive	-	-	-	-
Aurora System	User	Inactive	-	-	-	-
Broadcom Ltd.	Producer	Inactive	-	-	-	-
Cadence Design Systems	User	Active	Х	Х	Х	Х
Celestica	User	Inactive	-	-	-	-
Cisco Systems	User	Inactive	-	-	-	-
Dassault Systems	User	Inactive	-	-	-	-
GE Healthcare Technologies	User	Inactive	-	-	-	-
Google	User	Inactive	-	-	-	-
Huawei Technologies	Producer	Inactive	-	-	-	-
Infineon Technologies AG	Producer	Inactive	-	-	-	-
Intel Corp.	Producer	Active	Х	Х	Х	Х
Keysight Technologies	User	Inactive	-	-	-	-
Marvell	Producer	Inactive	Х	Х	-	-
MathWorks	User	Active	Х	Х	Х	Х
Micron Technology	Producer	Inactive	-	-	-	-
MST EMC Lab	User	Inactive	Х	-	-	-
SI-Clarity	User	Active	Х	х	Х	Х
Siemens EDA	User	Active	х	х	Х	Х
STMicroelectronics	Producer	Inactive	Х	-	-	-
Synopsys	User	Active	Х	х	Х	Х
ZTE Corp.	User	Inactive	-	-	-	-
Zuken	User	Active	Х	Х	Х	Х

= Temporarily not a voting member

Criteria for SAE member in good standing:

- Must attend two consecutive meetings to establish voting membership.
- Membership dues current
- Must not miss two consecutive meetings (voting by email counts as attendance)
- Interest categories associated with SAE standards ballot voting are:
  - Users members that utilize electronic equipment to provide services to an end user.
  - Producers members that supply electronic equipment.

General Interest - members are neither producers nor users. This category includes, but is not limited to, government, regulatory agencies (state and federal), researchers, other organizations, and associations, and/or consumers.